High and Low Side Driver

Features

- Floating channel designed for bootstrap operation
- Fully operational to 200V
- Tolerant to negative transient voltage, dV/dt immune
- Gate drive supply range from 10 to 20V
- Undervoltage lockout for both channels
- 3.3V logic compatible
- Separate logic supply range from 3.3V to 20V
- Logic and power ground +/-5V offset
- CMOS Schmitt-triggered inputs with pull-down
- Shut down input turns off both channels
- Cross-conduction prevention logic
- Matched propagation delay for both channels
- Outputs in phase with inputs

Description

The IR2010 is a high power, high voltage, high speed power MOSFET and IGBT driver with independent high and low side referenced output channels. Logic inputs are compatible with standard CMOS or LSTTL output, down to 3.0V logic. The output drivers feature a high pulse current buffer stage designed for minimum driver cross-conduction. Propagation delays are matched to simplify use in high frequency applications. The floating channel can be used to drive an Nchannel power MOSFET or IGBT in the high side configuration which operates up to 200 volts. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction.

Applications

- Converters
- DC motor drive

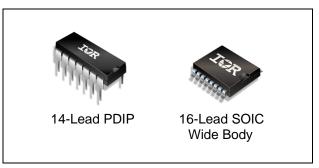
Ordering Information

Deer Dert Neuriter		Standar	d Pack	Onderselle Development
Base Part Number	Number Package Type		Quantity	Orderable Part Number
IR2010PBF	PDIP14	Tube	25	IR2010PBF
IR2010SPBF	SO16W	Tube	45	IR2010SPBF
IR2010SPBF	SO16W	Tape and Reel	1000	IR2010STRPBF

Product Summary

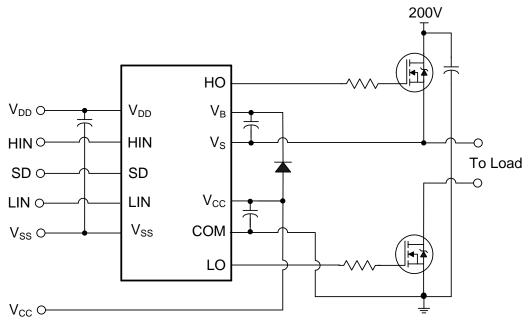
V _{OFFSET} (max)	200V
I _{O+/-} (typ)	3.0A / 3.0A
V _{OUT}	10 – 20V
t _{on/off} (typ)	95ns & 65ns
Delay Matching (max)	15ns

Package Options





Typical Connection Diagram



(Refer to Lead Assignments for correct configuration.) This diagram shows electrical connections only. Please refer to our Application Notes and Design Tips for proper circuit board layout



Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

Symbol	Definition	Min.	Max.	Units	
V _B	High side floating supply voltage		-0.3	225	
Vs	High side floating supply offset volta	ge	V _B - 25	V _B + 0.3	
V _{HO}	High side floating output voltage		V _S - 0.3	V _B + 0.3	V
V _{cc}	Low side fixed supply voltage		-0.3	25	v
V _{LO}	Low side output voltage		-0.3	V _{CC} + 0.3	
V _{DD}	Logic supply voltage		-0.3	V _{SS} + 25	
V _{SS}	Logic supply offset voltage		V _{CC} - 25	V _{CC} + 0.3	
V _{IN}	Logic input voltage (HIN, LIN & SD)		V _{SS} - 0.3	V _{DD} + 0.3	
dV _s /dt	Allowable offset supply voltage trans	sient (figure 2)	_	50	V/ns
D	Package power dissipation	14-Lead PDIP	_	1.6	W
P _D	@ T _A ≤ +25°C	16-Lead SOIC		1.25	vv
Dth	Thermal resistance, junction to	14-Lead PDIP		75	0000
Rth _{JA}	Rth _{JA} ambient		_	100	°C/W
TJ	Junction temperature		150		
Ts	Storage temperature	-55	150	°C	
TL	Lead temperature (soldering, 10 sec	_	300		

Recommended Operating Conditions

The input/output logic timing diagram is shown in figure 1. For proper operation the device should be used within the recommended conditions. The V_s and V_{ss} offset rating is tested with all supplies biased at 15V differential. Typical ratings at other bias conditions are shown in figures 24 and 25.

Symbol	Definition	Min.	Max.	Units
V _B	High side floating supply absolute voltage	V _S + 10	V _S + 20	
Vs	High side floating supply offset voltage	+	200	
V _{HO}	High side floating output voltage	Vs	V _B	V
V _{cc}	Low side fixed supply voltage	10	20	-
V _{LO}	Low side output voltage	0	V _{cc}	
V _{DD}	Logic supply voltage	V _{SS} + 3	V _{SS} + 20	
V _{SS}	Logic supply offset voltage	-5 ^{††}	5	
V _{IN}	Logic input voltage (HIN, LIN, & SD)	V _{SS}	V _{DD}	
T _A	Ambient temperature	-40	125	°C

+ Logic operational for V_S of -4 to +200V. Logic state held for V_S of -4V to -V_{BS}.

++ When V_{DD} < 5V, the minimum V_{SS} offset is limited to - V_{DD}

(Please refer to the Design Tip DT97-3 for more details).

Dynamic Electrical Characteristics

 V_{BIAS} (V_{CC} , V_{BS} , V_{DD}) = 15V, C_L = 1000pF and T_A = 25°C and V_{SS} = COM unless otherwise specified. The dynamic electrical characteristics are measured using the test circuit shown in figure 3.

Symbol	Definition	Figure	Min.	Тур.	Max.	Units	Test Conditions
t _{on}	Turn-on propagation delay	7	50	95	135		$V_{S} = 0V$
t _{off}	Turn-off propagation delay	8	30	65	105		V _S = 200V
t _{sd}	Shutdown propagation delay	9	35	70	105	n 0	V _S = 200V
t _r	Turn-on rise time	10		10	20	ns	
t _f	Turn-off fall time	11		15	25		
MT	Delay matching, HS & LS turn-on/off	6		—	15		

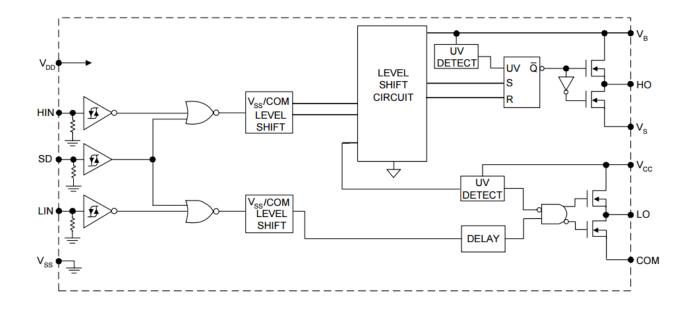
Static Electrical Characteristics

 V_{BIAS} (V_{CC} , V_{BS} , V_{DD}) = 15V and T_A = 25°C and V_{SS} = COM unless otherwise specified. The V_{IN} , V_{TH} and I_{IN} parameters are referenced to V_{SS} and are applicable to all three logic input leads: HIN, LIN and SD. The V_O and I_O parameters are referenced to COM and are applicable to the respective output leads: HO or LO.

Symbol	Definition	Figure	Min.	Тур.	Max.	Units	Test Conditions	
V _{IH}	Logic "1" input voltage	12	9.5	—	—		V _{DD} = 15V	
V _{IL}	Logic "0" input voltage	13	—	—	6.0		$v_{DD} = 15v$	
V _{IH}	Logic "1" input voltage	12	2	—	—	V	V _{DD} = 3.3V	
V _{IL}	Logic "0" input voltage	13	—		1	v	$v_{DD} = 3.3 v$	
V _{OH}	High level output voltage, V_{BIAS} - V_{O}	14	—		1.0		$I_{O} = 0A$	
V _{OL}	Low level output voltage, V_O	15	—		0.1		$I_0 = 0A$	
I _{LK}	Offset supply leakage current	16	—		50		$V_B = V_S = 200V$	
I _{QBS}	Quiescent V _{BS} supply current	17	—	70	210			
I _{QCC}	Quiescent V _{cc} supply current	18	—	100	230	μA	$V_{IN} = 0V \text{ or } V_{DD}$	
	Quiescent V _{DD} supply current	19	—	1	5	μΑ		
I _{IN+}	Logic "1" input bias current	20	—	20	40		$V_{IN} = V_{DD}$	
I _{IN-}	Logic "0" input bias current	21	—		1.0		$V_{IN} = 0V$	
V _{BSUV+}	V _{BS} supply undervoltage positive going threshold	22	7.5	8.6	9.7			
V _{BSUV-}	V _{BS} supply undervoltage negative going threshold	23	7.0	8.2	9.4	v		
V _{CCUV+}	V _{CC} supply undervoltage positive going threshold	24	7.5	8.6	9.7	V		
V _{CCUV-}	V _{CC} supply undervoltage negative going threshold	25	7.0	8.2	9.4			
I _{O+}	Output high short circuit pulsed current	26	2.5	3.0	_	Α	$V_{\rm O} = 0V, V_{\rm IN} = V_{\rm DD}$ $PW \le 10 \ \mu s$	
I _{O-}	Output low short circuit pulsed current	27	2.5	3.0	_		$V_{\rm O} = 15 {\rm V}, V_{\rm IN} = 0 {\rm V} \\ {\rm PW} \leq 10 \ \mu {\rm s} \label{eq:VO}$	



Functional Block Diagram

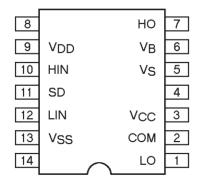




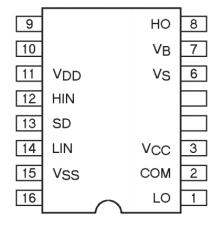
Lead Definitions

Symbol	Description	
V _{DD}	Logic Supply	
HIN	Logic input for high side gate driver outputs (HO), in phase	
SD	Logic input for shutdown	
LIN	Logic input for low side gate driver outputs (LO), in phase	
V _{SS}	Logic ground	
V _B	High side floating supply	
HO	High side gate drive output	
Vs	High side floating supply return	
V _{CC}	Low side supply	
LO	Low side gate drive output	
COM	Low side return	

Lead Assignments



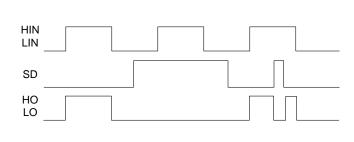
14-Lead PDIP



16-Lead SOIC (Wide Body)



Application Information and Additional Details





v

HC

LC

СОМ

 $V_{CC} = 15V$

V_{DD} V_{CC} V_B

HIN

SD

LIN

0.1µF

10µF

SD O

LIN O

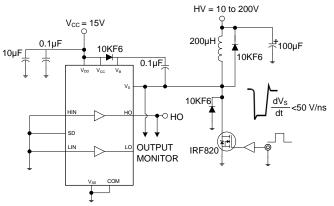
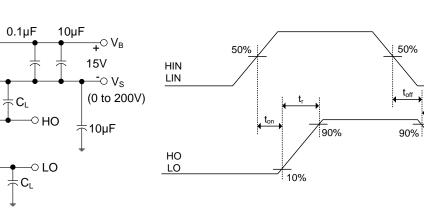


Figure 2. Floating Supply Voltage Transient Test Circuit





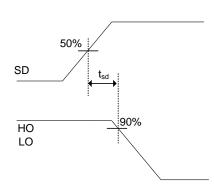




Figure 4. Switching Time Waveform Definition

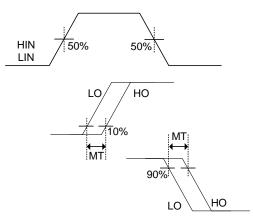


Figure 6. Delay Matching Waveform Definitions

tf

10%



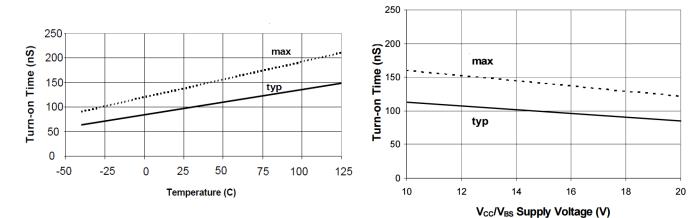


Figure 7A. Turn-on Time vs. Temperature

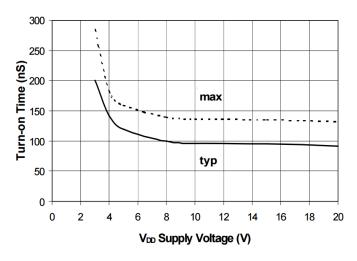


Figure 7C. Turn-on Time vs. V_{DD} Voltage

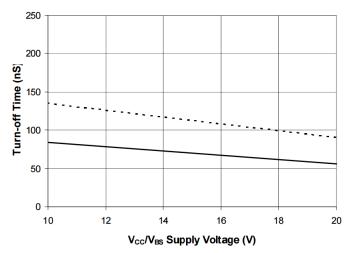




Figure 7B. Turn-on Time vs. V_{cc}/V_{BS} Voltage

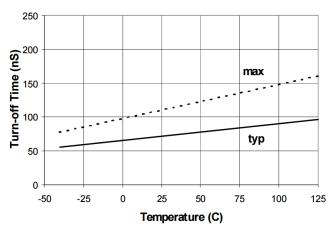


Figure 8A. Turn-off Time vs. Temperature

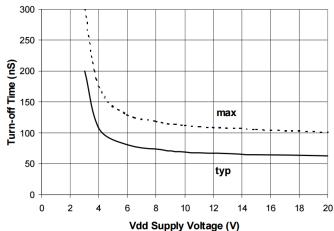


Figure 8C. Turn-off Time vs. V_{DD} Voltage



18

20

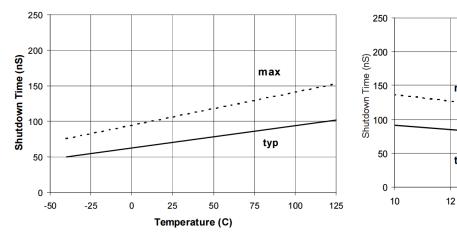


Figure 9A. Shutdown Time vs. Temperature

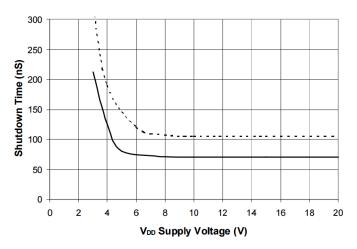
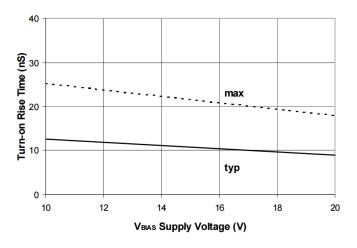


Figure 9C. Shutdown Time vs. V_{DD} Voltage



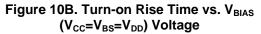


Figure 9B. Shutdown Time vs. V_{CC}/V_{BS} Voltage

16

Vcc/VBS Supply Voltage (V)

14

max

typ

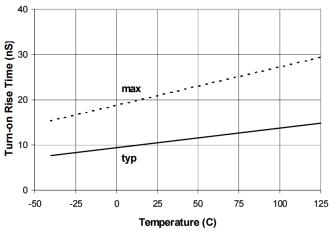


Figure 10A. Turn-on Rise Time vs. Temperature

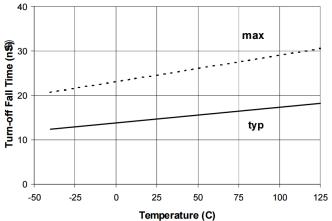
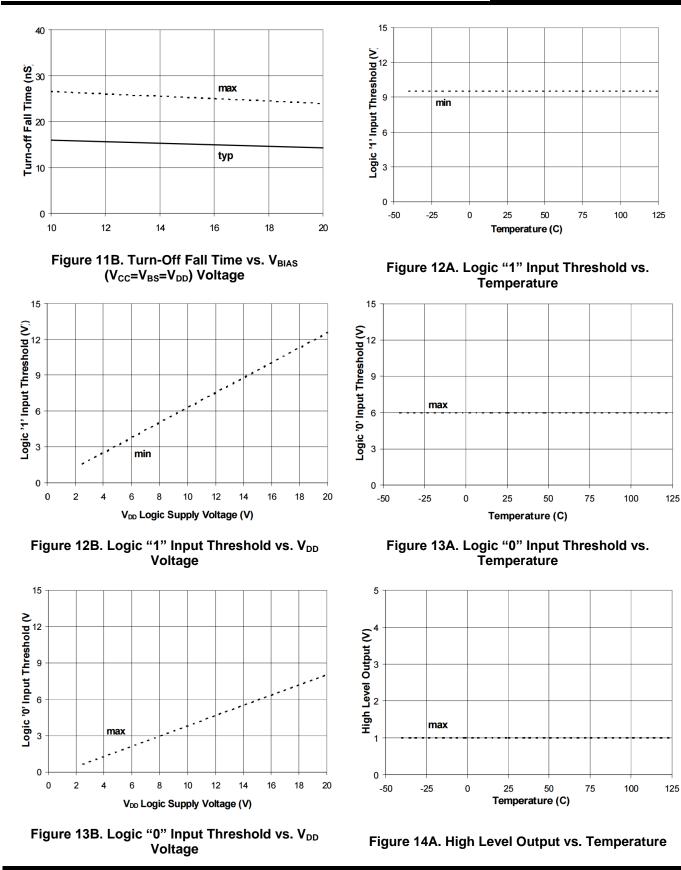


Figure 11A. Turn-off Fall Time vs. Temperature







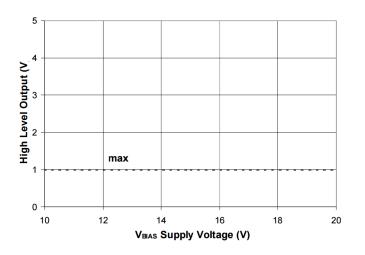


Figure 14B. High Level Output vs. V_{BIAS} Voltage

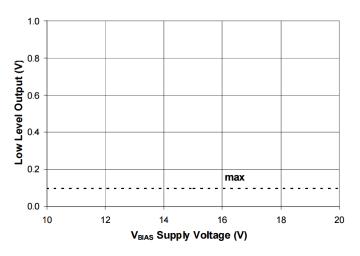


Figure 15B. Low Level Output vs. V_{BIAS} Voltage

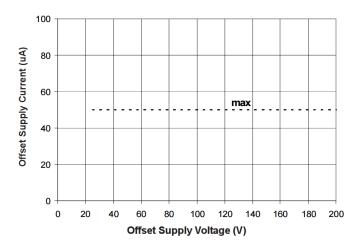


Figure 16B. Offset Supply Current vs. Offset Voltage

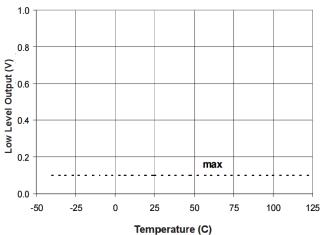


Figure 15A. Low Level Output vs. Temperature

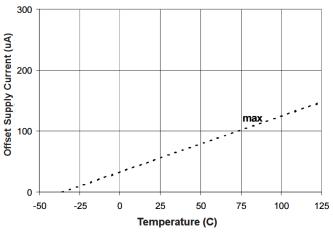
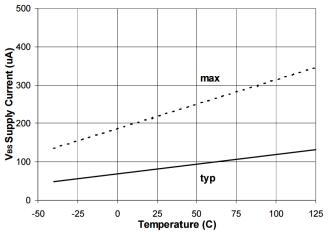
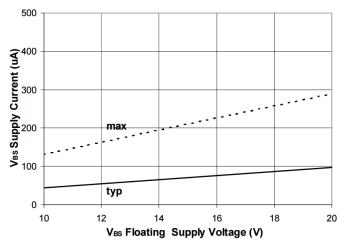


Figure 16A. Offset Supply Current vs. Temperature











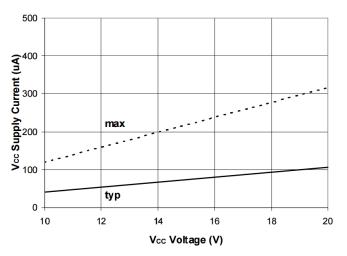


Figure 18B. V_{CC} Supply Current vs. V_{CC} Voltage

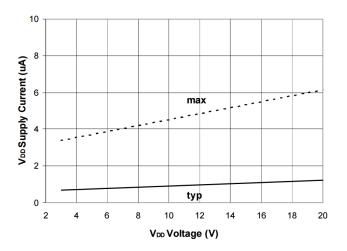


Figure 19B. V_{DD} Supply Current vs. V_{DD} Voltage

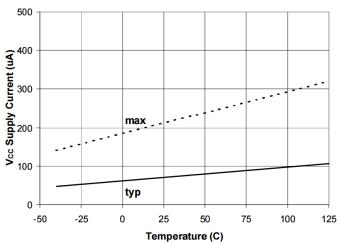


Figure 18A. V_{cc} Supply Current vs. Temperature

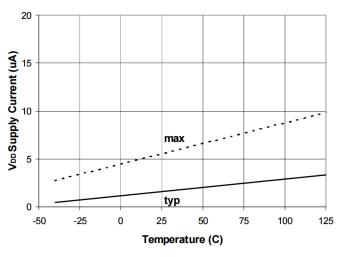


Figure 19A. V_{DD} Supply Current vs. Temperature

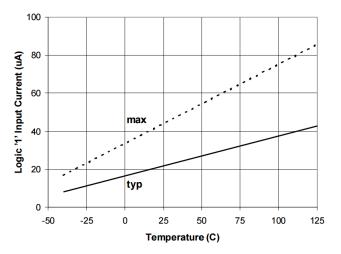


Figure 20A. Logic "1"Input Current vs. Temperature



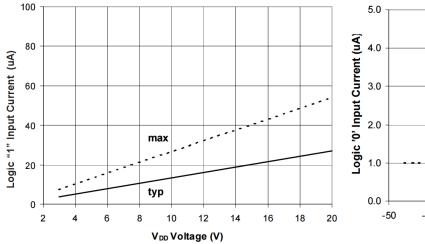


Figure 20B. Logic "1" Input Current vs. V_{DD} Voltage

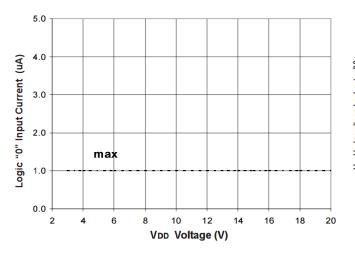
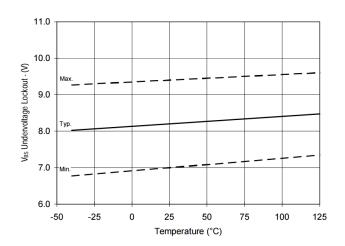


Figure 21B. Logic "0" Input Current vs. V_{DD} Voltage





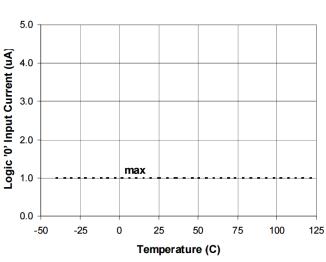


Figure 21A. Logic "0" Input Current vs. Temperature

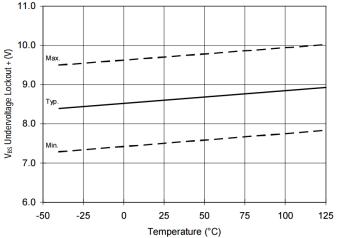
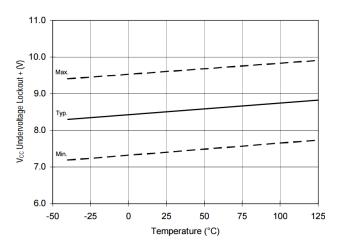
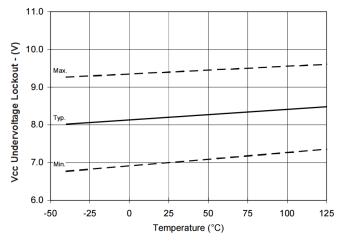


Figure 22. V_{BS} Undervoltage (+) vs. Temperature











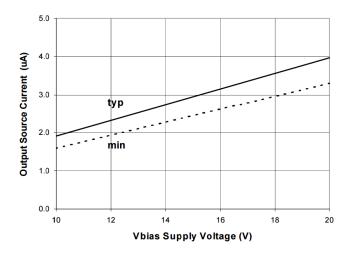
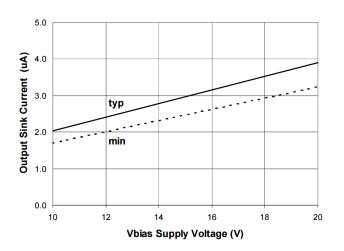


Figure 26B. Output Source Current vs. V_{BIAS} Voltage





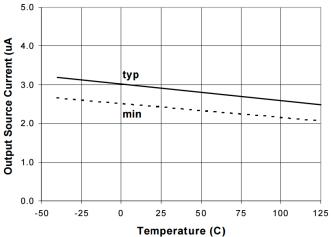
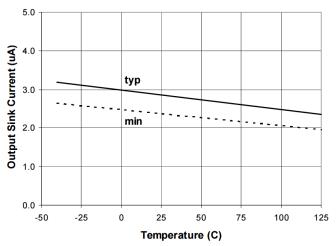
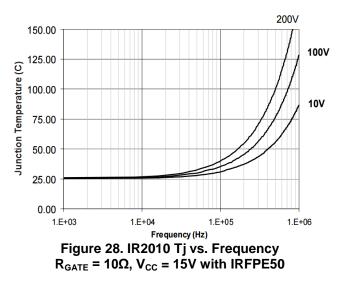


Figure 26A. Output Source Current vs. Temperature









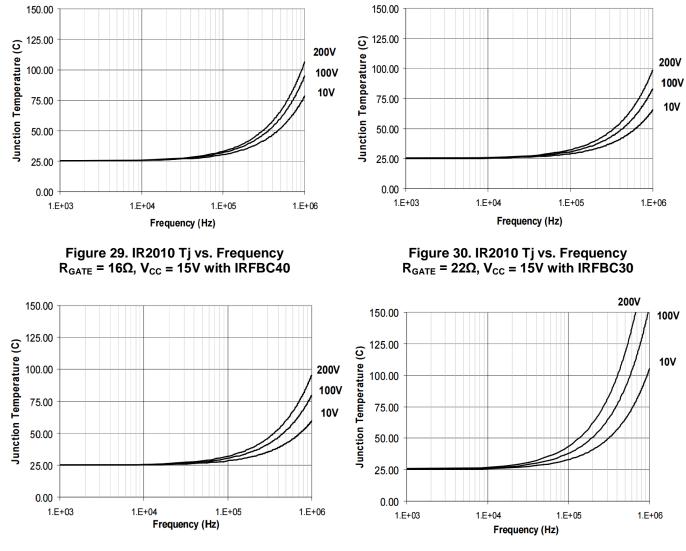
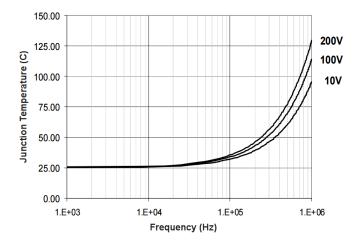
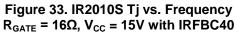


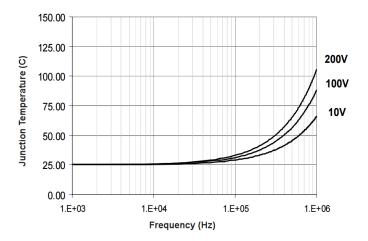
Figure 31. IR2010 Tj vs. Frequency $R_{GATE} = 33\Omega$, $V_{CC} = 15V$ with IRFBC20

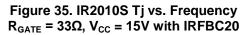
Figure 32. IR2010 Tj vs. Frequency $R_{GATE} = 10\Omega$, $V_{CC} = 15V$ with IRFBE50











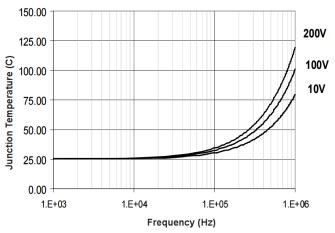
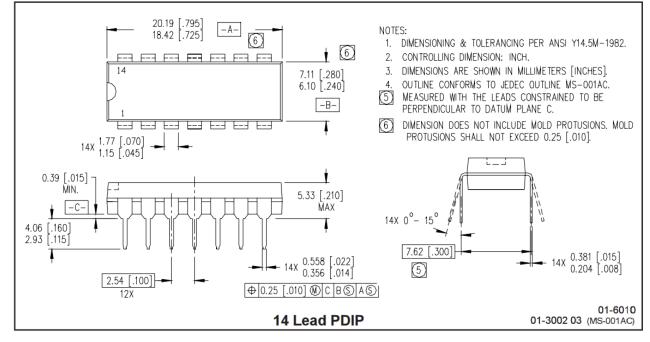
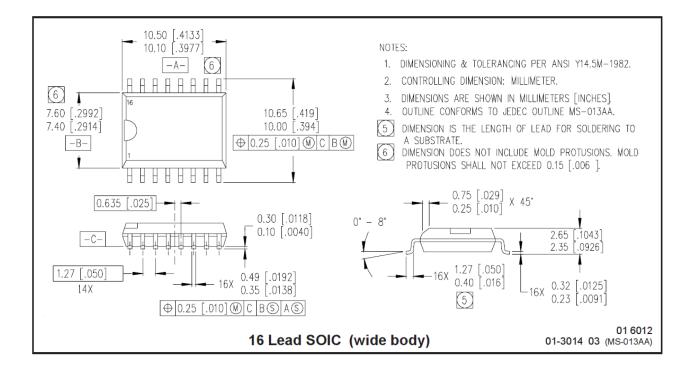


Figure 34. IR2010S Tj vs. Frequency $R_{GATE} = 22\Omega$, $V_{CC} = 15V$ with IRFBC30



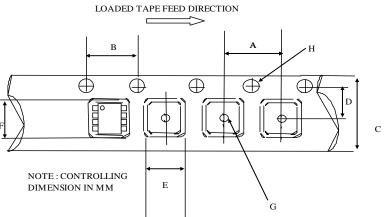
Package Details





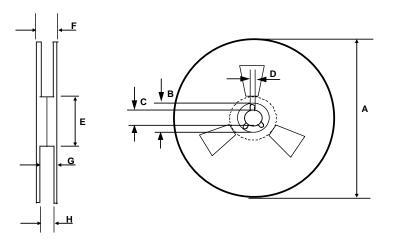


Tape and Reel Details



CARRIER TAPE DIMENSION FOR 16SOICW

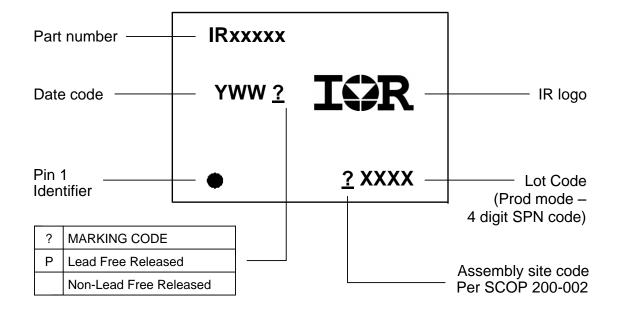
	Me	tric	Imp	erial
Code	Min	Max	Min	Max
A	11.90	12.10	0.468	0.476
В	3.90	4.10	0.153	0.161
С	15.70	16.30	0.618	0.641
D	7.40	7.60	0.291	0.299
E	10.80	11.00	0.425	0.433
F	10.60	10.80	0.417	0.425
G	1.50	n/a	0.059	n/a
Н	1.50	1.60	0.059	0.062



	Me	tric	Imperial		
Code	Min	Max	Min	Max	
A	329.60	330.25	12.976	13.001	
В	20.95	21.45	0.824	0.844	
С	12.80	13.20	0.503	0.519	
D	1.95	2.45	0.767	0.096	
E	98.00	102.00	3.858	4.015	
F	n/a	22.40	n/a	0.881	
G	18.50	21.10	0.728	0.830	
Н	16.40	18.40	0.645	0.724	



Part Marking Information



Qualification Information[†]

		Industrial ^{††} (per JEDEC JESD 47)		
Qualification Level		Comments: This family of ICs has passed JEDEC's Industrial qualification. IR's Consumer qualification level is granted by extension of the higher Industrial level.		
Moisture Sensitivity Level	16-Lead SOIC WB	MSL3 ^{†††} (per IPC/JEDEC J-STD-020)		
RoHS Compliant		Yes		

- † Qualification standards can be found at International Rectifier's web site http://www.irf.com/
- ++ Higher qualification ratings may be available should the user have such requirements. Please contact your International Rectifier sales representative for further information.
- +++ Higher MSL ratings may be available for the specific package types listed here. Please contact your International Rectifier sales representative for further information.

The information provided in this document is believed to be accurate and reliable. However, International Rectifier assumes no responsibility for the consequences of the use of this information. International Rectifier assumes no responsibility for any infringement of patents or of other rights of third parties which may result from the use of this information. No license is granted by implication or otherwise under any patent or patent rights of International Rectifier. The specifications mentioned in this document are subject to change without notice. This document supersedes and replaces all information previously supplied.

For technical support, please contact IR's Technical Assistance Center <u>http://www.irf.com/technical-info/</u>

> WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245 Tel: (310) 252-7105

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

International Rectifier: IR2010SPBF IR2010PBF IR2010STRPBF